

DMP2040UVT-13 Datasheet



DiGi Electronics Part Number

Manufacturer

Manufacturer Product Number

Description

Detailed Description

DMP2040UVT-13-DG

Diodes Incorporated

DMP2040UVT-13

MOSFET P-CH 20V TSOT26

P-Channel 20 V 5.5A (Ta), 13A (Tc) 1.2W (Ta) Surfac e Mount TSOT-26

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Purchase and inquiry

Manufacturer Product Number:	Manufacturer:
DMP2040UVT-13	Diodes Incorporated
Series:	Product Status:
-	Active
FET Type:	Technology:
P-Channel	MOSFET (Metal Oxide)
Drain to Source Voltage (Vdss):	Current - Continuous Drain (ld) @ 25°C:
20 V	5.5A (Ta), 13A (Tc)
Drive Voltage (Max Rds On, Min Rds On):	Rds On (Max) @ ld, Vgs:
2.5V, 4.5V	38mOhm @ 8.9A, 4.5V
Vgs(th) (Max) @ ld:	Gate Charge (Qg) (Max) @ Vgs:
1.5V @ 250µA	8.6 nC @ 4.5 V
Vgs (Max):	Input Capacitance (Ciss) (Max) @ Vds:
±12V	834 pF @ 10 V
FET Feature:	Power Dissipation (Max):
-	1.2W (Ta)
Operating Temperature:	Mounting Type:
-55°C ~ 150°C (TJ)	Surface Mount
Supplier Device Package:	Package / Case:
TSOT-26	SOT-23-6 Thin, TSOT-23-6
Base Product Number:	
DMP2040	

Environmental & Export classification

RoHS Status:	Moisture Sensitivity Level (MSL):
ROHS3 Compliant	1 (Unlimited)
REACH Status:	ECCN:
REACH Unaffected	EAR99
HTSUS:	
8541.29.0095	





Product Summary

BV _{DSS}	R _{DS(ON) Max}	Ι _D T _A = +25°C
-20V	38mΩ @ V _{GS} = -4.5V	-5.5A
	$52m\Omega @ V_{GS} = -2.5V$	-5.0A

Description and Applications

This MOSFET is designed to minimize the on-state resistance $(R_{DS(ON)})$ and yet maintain superior switching performance, making it ideal for high-efficiency power management applications.

- DC-DC Converters
- Motor Control
- Power Management Functions
- Analog Switch

P-CHANNEL ENHANCEMENT MODE MOSFET

Features and Benefits

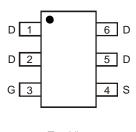
- Low Input Capacitance
- Low On-Resistance
- Fast Switching Speed
- Totally Lead-Free & Fully RoHS Compliant (Notes 1 & 2)
- Halogen and Antimony Free. "Green" Device (Note 3)

Mechanical Data

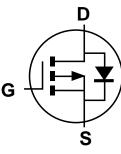
- Case: TSOT26
- Case Material: Molded Plastic, "Green" Molding Compound. UL Flammability Classification Rating 94V-0
- Moisture Sensitivity: Level 1 per J-STD-020
- Terminal Connections: See Diagram
- Terminals: Finish Matte Tin Annealed over Copper Leadframe; Solderable per MIL-STD-202, Method 208 (3)
- Weight: 0.013 grams (Approximate)



Top View



Top View Pin-Out



Equivalent Circuit

Ordering Information (Note 4)

Part Number	Case	Packaging
DMP2040UVT-7	TSOT26	3,000/Tape & Reel
DMP2040UVT-13	TSOT26	10,000/Tape & Reel

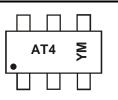
Notes: 1. No purposely added lead. Fully EU Directive 2002/95/EC (RoHS) & 2011/65/EU (RoHS 2) compliant.

2. See http://www.diodes.com/quality/lead_free.html for more information about Diodes Incorporated's definitions of Halogen- and Antimony-free, "Green" and Lead-free.

3. Halogen- and Antimony-free "Green" products are defined as those which contain <900ppm bromine, <900ppm chlorine (<1500ppm total Br + Cl) and <1000ppm antimony compounds.

4. For packaging details, go to our website at https://www.diodes.com/design/support/packaging/diodes-packaging/.

Marking Information



AT4 = Product Type Marking Code

- YM = Date Code Marking
- Y or \overline{Y} = Year (ex: E = 2017)
- M = Month (ex: 9 = September)

Date	Code	Kov
Dale	Code	ney

Year	2017	2018	20	019	2020	2021	1	2022	2023	20	24	2025
Code	E	F		G	Н	I		J	К	L		М
Month	Jan	Feb	Mar	Apr	Мау	Jun	Jul	Aug	Sep	Oct	Nov	Dec
Code	1	2	3	4	5	6	7	8	9	0	N	D



Maximum Ratings (@T_A = +25°C, unless otherwise specified.)

Characteristic	Symbol	Value	Unit		
Drain-Source Voltage			V _{DSS}	-20	V
Gate-Source Voltage			V _{GSS}	±12	V
Continuous Drain Current (Note 6) V_{GS} = -4.5V	ID	-5.5 -4.5	А		
Continuous Drain Current (Note 7) V_{GS} = -4.5V	Steady State	T _C = +25°C T _C = +70°C	ID	-13 -10	А
Pulsed Drain Current (10µs Pulse, Duty Cycle = 1%)			I _{DM}	-40	А
Continuous Source-Drain Diode Current (Note 6)	Is	-2.2	А		
Avalanche Current (Note 8) L = 0.1mH	IAS	-16	А		
Avalanche Energy (Note 8) L = 0.1mH	E _{AS}	13.5	mJ		

Thermal Characteristics (@T_A = +25°C, unless otherwise specified.)

Characteristic		Symbol	Value	Unit
Total Power Dissipation (Note 5)	T _A = +25°C	PD	1.2	W
Thermal Resistance, Junction to Ambient (Note 5)	Steady State	R _{θJA}	105	°C/W
Total Power Dissipation (Note 6)	T _A = +25°C	PD	1.5	W
Thermal Resistance, Junction to Ambient (Note 6)	Steady State	R _{0JA}	80	°C/W
Thermal Resistance, Junction to Case (Note 7)	Steady State	R _{θJC}	16	°C/W
Operating and Storage Temperature Range		T _J , T _{STG}	-55 to +150	°C

Electrical Characteristics (T_A = +25°C, unless otherwise specified.)

Characteristic	Symbol	Min	Тур	Max	Unit	Test Condition
OFF CHARACTERISTICS (Note 9)						
Drain-Source Breakdown Voltage	BV _{DSS}	-20	—	—	V	$V_{GS} = 0V, I_D = -250\mu A$
Zero Gate Voltage Drain Current	IDSS	_	—	-1	μA	$V_{DS} = -16V, V_{GS} = 0V$
Gate-Source Leakage	Igss		_	±100	nA	$V_{GS} = \pm 12V, V_{DS} = 0V$
ON CHARACTERISTICS (Note 9)						
Gate Threshold Voltage	V _{GS(TH)}	-0.6	—	-1.5	V	$V_{DS} = V_{GS}$, $I_D = -250 \mu A$
Static Drain-Source On-Resistance	Deserver	_	27	38	mΩ	$V_{GS} = -4.5V, I_D = -8.9A$
Static Drain-Source On-Resistance	R _{DS(ON)}	_	38	52	11122	$V_{GS} = -2.5V, I_D = -6.9A$
Diode Forward Voltage	V _{SD}	_	-0.7	-1.2	V	V _{GS} = 0V, I _S = -2.9A
DYNAMIC CHARACTERISTICS (Note 10)						•
Input Capacitance	C _{iss}	_	834	—		
Output Capacitance	Coss	_	133	—	pF	$V_{DS} = -10V, V_{GS} = 0V,$ f = 1.0MHz
Reverse Transfer Capacitance	C _{rss}	—	105	—		
Gate Resistance	R _G	—	4.9	—	Ω	$V_{DS} = 0V, V_{GS} = 0V, f = 1.0MHz$
Total Gate Charge (V _{GS} = -4.5V)	Qg	—	8.6	—		
Total Gate Charge (V _{GS} = -8V)	Qg	_	19	—	nC	V _{DS} = -6V. I _D = -8.9A
Gate-Source Charge	Q _{gs}	_	1.5	—	ne	$v_{\rm DS} = -6v, i_{\rm D} = -8.9A$
Gate-Drain Charge	Q _{gd}	_	2.5	—		
Turn-On Delay Time	t _{D(ON)}		5.8	_		
Turn-On Rise Time	t _R		7.7	_		$V_{DD} = -6V, R_L = 6\Omega$
Turn-Off Delay Time	t _{D(OFF)}	_	28.1	_	ns	$V_{GS} = -4.5V, R_G = 6\Omega, I_D = -1A$
Turn-Off Fall Time	t _F	_	14.6	_	1	
Body Diode Reverse Recovery Time	t _{RR}	_	9.8	_	ns	I _F = -8.9A, di/dt = -100A/μs
Body Diode Reverse Recovery Charge	Q _{RR}		2.7	_	nC	I _F = -8.9A, di/dt = -100A/µs

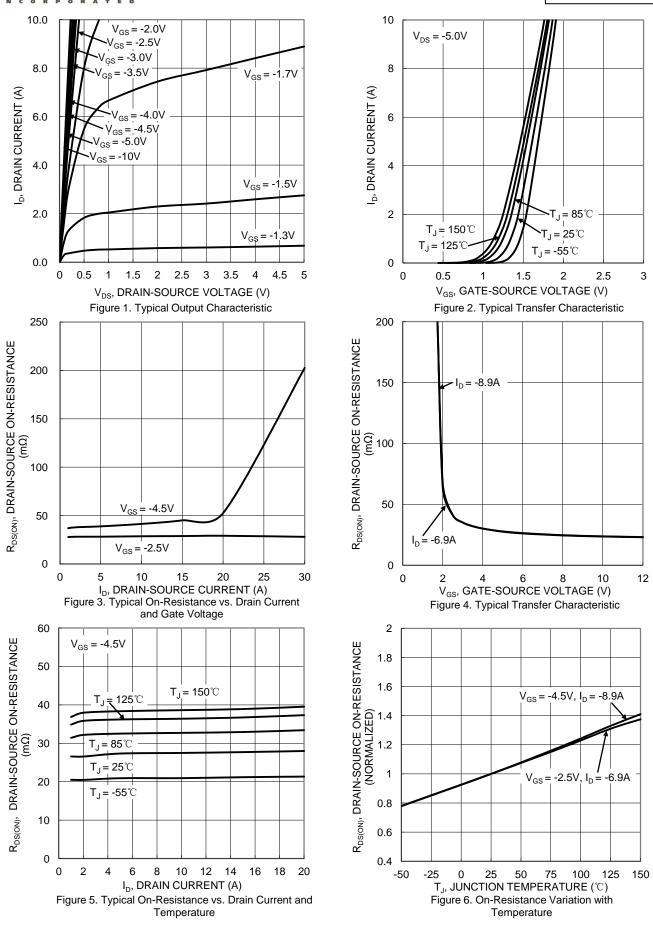
5. Device mounted on FR-4 PC board, with minimum recommended pad layout, single sided. Notes:

6. Device mounted on FR-4 substrate PC board, 2oz copper, with thermal bias to bottom layer 1inch square copper plate.

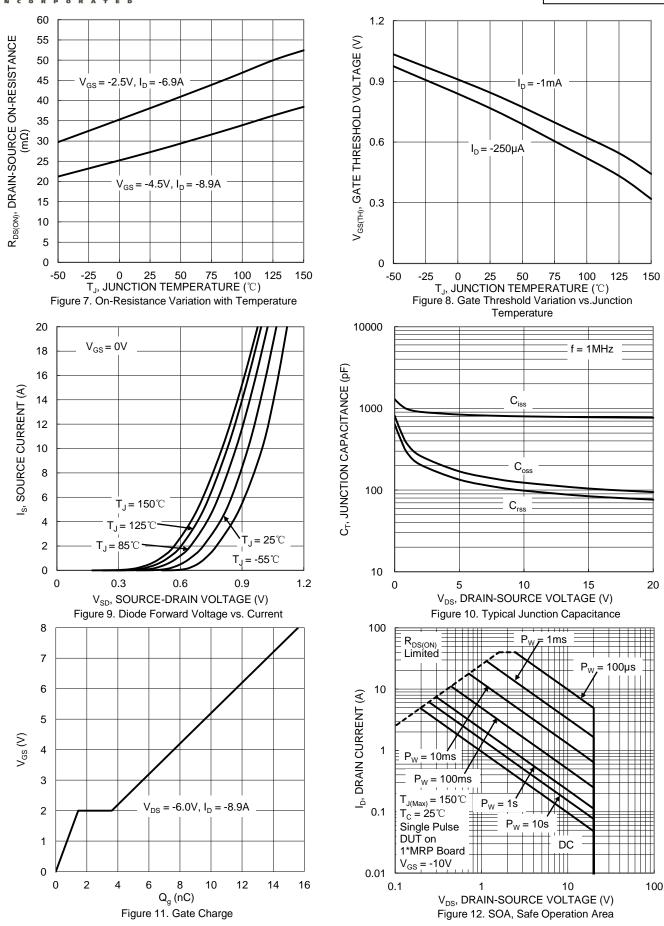
7. Thermal resistance from junction to soldering point (on the exposed drain pad).

8. I_{AS} and E_{AS} ratings are based on low frequency and duty cycles to keep $T_J = +25^{\circ}C$. 9. Short duration pulse test used to minimize self-heating effect. 10. Guaranteed by design. Not subject to product testing.



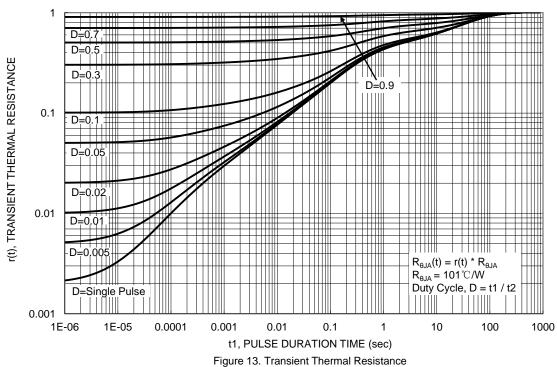






DMP2040UVT Document number: DS40060 Rev. 2 - 2

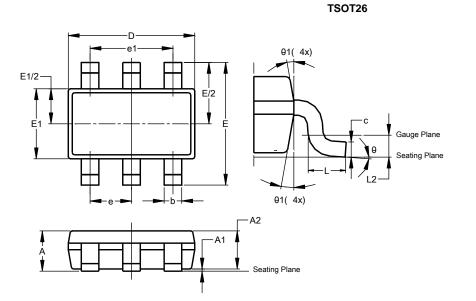






Package Outline Dimensions

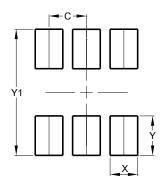
Please see http://www.diodes.com/package-outlines.html for the latest version.



	TSOT26							
Dim	Min	Max	Тур					
Α	-	1.00	-					
A1	0.010	0.100	-					
A2	0.840	0.900	-					
D	2.800	3.000	2.900					
E	2	.800 BS	C					
E1	1.500	1.700	1.600					
b	0.300	0.450	-					
С	0.120	0.200	-					
е	0.950 BSC							
e1	1	.900 BS	С					
L	0.30	0.50	-					
L2	0.250 BSC							
θ	0°	8°	4°					
θ1	4°	12°	-					
A	II Dimen	sions in	mm					

Suggested Pad Layout

Please see http://www.diodes.com/package-outlines.html for the latest version.



TSOT26

Dimensions	Value (in mm)
С	0.950
Х	0.700
Y	1.000
Y1	3.199



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